

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	356	wafer\$4 same solder\$4 same lower same upper	US-PGPUB; USPAT	OR	OFF	2006/03/28 14:46
L2	1	"6525864".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:10
L3	1	"6781208".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:11
L4	1	"6781239".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:12
L5	1	"6946321".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/28 15:13
S1	47	wafer\$4 same solder\$4 same (reflect\$4 or mirror\$4) same electro\$4	US-PGPUB; USPAT	OR	OFF	2006/03/28 13:49
S2	0	(wafer\$4 same microstructu\$4 same electro\$4) and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/05/27 07:53
S3	2	(wafer\$4 same microstructu\$4 same electro\$4) and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:04
S4	118	(wafer\$4 same microstructu\$4 same electro\$4)	US-PGPUB; USPAT	OR	OFF	2005/05/27 07:55
S5	22	(wafer\$4 same microstructu\$4 same electro\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:04
S6	2045	(wafer\$4 same electro\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT	OR	OFF	2005/05/27 12:58
S7	81	S6 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/05/27 08:00
S8	80	S7 not S5	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:05
S9	144719	"8" and solder\$4	US-PGPUB; USPAT	OR	OFF	2005/05/27 12:57
S10	23	(wafer\$4 same electro\$4 same (mirror\$4 or reflect\$4)) and solder\$4 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:57
S11	793	wafer same solder\$4 same ((flip\$ or chip\$4 or bond\$4) and adhesive)	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:41
S12	84	wafer same solder\$4 same ((flip\$ with chip\$4 with bond\$4) and adhesive)	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:41
S13	58	wafer\$4 same solder\$4 same (reflect\$4 or mirror\$4) same electro\$4	US-PGPUB; USPAT	OR	OFF	2005/11/16 14:56

## EAST Search History

S14	36	(wafer\$4 same microstructu\$4 same electroded\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:09
S15	28	(wafer\$4 same electroded\$4 same (mirror\$4 or reflect\$4)) and solder\$4 and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:07
S16	106	wafer\$4 same solder\$4 same (reflect\$4 or mirror\$4) same electroded\$4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:04
S17	3	(wafer\$4 same microstructu\$4 same electroded\$4) and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:04
S18	36	(wafer\$4 same microstructu\$4 same electroded\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:05
S19	36	(wafer\$4 same microstructu\$4 same electroded\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S20	2239	(wafer\$4 same electroded\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S21	90	S20 and 385/16-18.ccls.	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:07
S22	88	S21 not S19	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:07
S23	28	(wafer\$4 same electroded\$4 same (mirror\$4 or reflect\$4)) and solder\$4 and 385/16-18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:09

## EAST Search History

S24	36	(wafer\$4 same microstructu\$4 same electro\$4 same (mirror\$4 or reflect\$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:10
S25	812	(chip and bond\$4 and (interconnect\$4 connect\$4) and electri\$4 and terminal\$4).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:11
S26	32	(chip and bond\$4 and (interconnect\$4 connect\$4) and electri\$4 and terminal\$4 and (fiber\$4 fibre\$4)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:12
S27	4	(chip and bond\$4 and (interconnect\$4 connect\$4) and electri\$4 and terminal\$4 and (fiber\$4 fibre\$4) and pattern).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/11/16 18:12
S28	0	lin.xa. and tina.xa. and lens and bulge	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:51
S29	42	lin.xa. and tina.xa. and lens	US-PGPUB; USPAT	OR	OFF	2005/11/16 18:51
S30	251	solder\$4 same wafer\$4 same optic\$3 same (electronic or electri\$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/24 15:42